

N-channel TrenchMOS standard level FET Rev. 04 — 7 April 2010

**Product data sheet** 

#### **Product profile** 1.

#### 1.1 General description

Standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using Nexperia High-Performance Automotive (HPA) TrenchMOS technology. This product has been designed and qualified to the appropriate AEC standard for use in automotive critical applications.

#### 1.2 Features and benefits

- Q101 compliant
- Suitable for standard level gate drive sources

#### **1.3 Applications**

- 12 V and 24 V loads
- Advanced braking systems (ABS)
- Automotive systems

#### 1.4 Quick reference data

- Suitable for thermally demanding environments due to 175 °C rating
- Engine management
- General purpose power switching
- Motors, lamps and solenoids

Table 1.	Quick reference da	ta				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C	-	-	55	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; see <u>Figure 1</u> ; see <u>Figure 4</u>	-	-	47.4	Α
P <sub>tot</sub>	total power dissipation	$T_{mb} = 25 \text{ °C}; \text{ see } \frac{\text{Figure 2}}{2}$	-	-	85	W
Static cha	aracteristics					
R <sub>DSon</sub>	drain-source on-state resistance	$\label{eq:VGS} \begin{array}{l} V_{GS} = 10 \text{ V}; \text{ I}_{D} = 20 \text{ A}; \\ T_{j} = 25 \text{ °C}; \text{ see } \underline{\text{Figure 12}}; \\ \text{see } \underline{\text{Figure 13}} \end{array}$	-	12.7	18	mΩ
Avalanch	e ruggedness					
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$ \begin{split} I_D &= 47.4 \text{ A};  \text{V}_{\text{sup}} \leq 55 \text{ V}; \\ R_{\text{GS}} &= 50  \Omega;  \text{V}_{\text{GS}} = 10  \text{V}; \\ T_{j(\text{init})} &= 25 ^{\circ}\text{C}; \text{ unclamped} \end{split} $	-	-	77	mJ
Dynamic	characteristics					
$Q_{GD}$	gate-drain charge	I <sub>D</sub> = 20 A; V <sub>DS</sub> = 44 V; V <sub>GS</sub> = 10 V; see Figure 14	-	8.1	-	nC

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#### N-channel TrenchMOS standard level FET

### 2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source		_
2	S	source	mb ()	
3	S	source		
4	G	gate	٩	
mb	D	mounting base; connected to drain	$\begin{array}{c} & & \\ & & \\ & \\ 1 & 2 & 3 & 4 \end{array}$	mbb076 S
			SOT669 (LFPAK)	

### 3. Ordering information

Table 3.	Ordering in	formation		
Type number Package		Package		
		Name	Description	Version
BUK7Y18-	55B	LFPAK	plastic single-ended surface-mounted package (LFPAK); 4 leads	SOT669

N-channel TrenchMOS standard level FET

### 4. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

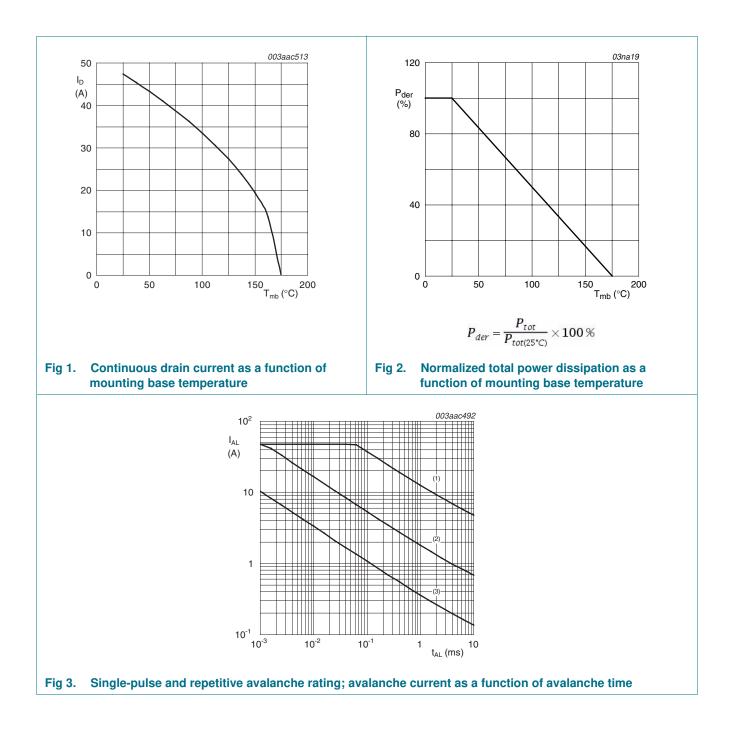
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C		-	-	55	V
V <sub>DGR</sub>	drain-gate voltage	$R_{GS} = 20 \text{ k}\Omega$		-	-	55	V
V <sub>GS</sub>	gate-source voltage			-20	-	20	V
I <sub>D</sub>	drain current	$T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V}; \text{ see } \frac{\text{Figure 1}}{\text{Figure 4}};$		-	-	47.4	A
		$T_{mb}$ = 100 °C; $V_{GS}$ = 10 V; see Figure 1		-	-	33.5	А
I <sub>DM</sub>	peak drain current	T <sub>mb</sub> = 25 °C; t <sub>p</sub> ≤ 10 μs; pulsed; see <u>Figure 4</u>		-	-	189	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>		-	-	85	W
T <sub>stg</sub>	storage temperature			-55	-	175	°C
Tj	junction temperature			-55	-	175	°C
Source-drai	in diode						
I <sub>S</sub>	source current	T <sub>mb</sub> = 25 °C		-	-	47.4	А
I <sub>SM</sub>	peak source current	$t_p \le 10 \ \mu s$ ; pulsed; $T_{mb} = 25 \ ^{\circ}C$		-	-	189	А
Avalanche r	ruggedness						
$E_{DS(AL)S}$	non-repetitive drain-source avalanche energy	$\label{eq:ld} \begin{array}{l} I_D = 47.4 \text{ A}; \ V_{sup} \leq 55 \text{ V}; \ R_{GS} = 50 \ \Omega; \\ V_{GS} = 10 \text{ V}; \ T_{j(init)} = 25 \ ^\circ\text{C}; \ unclamped \end{array}$		-	-	77	mJ
E <sub>DS(AL)R</sub>	repetitive drain-source avalanche energy	see Figure 3	<u>[1][2][3]</u>	-	-	-	J

[1] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.

[2] Repetitive avalanche rating limited by an average junction temperature of 170 °C.

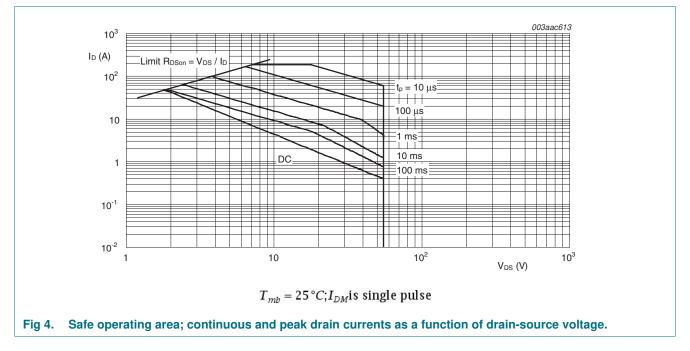
[3] Refer to application note AN10273 for further information.

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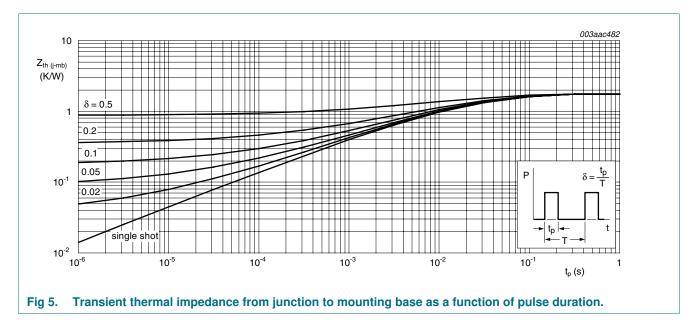
#### N-channel TrenchMOS standard level FET



### 5. Thermal characteristics

#### Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see <u>Figure 5</u>	-	-	1.76	K/W

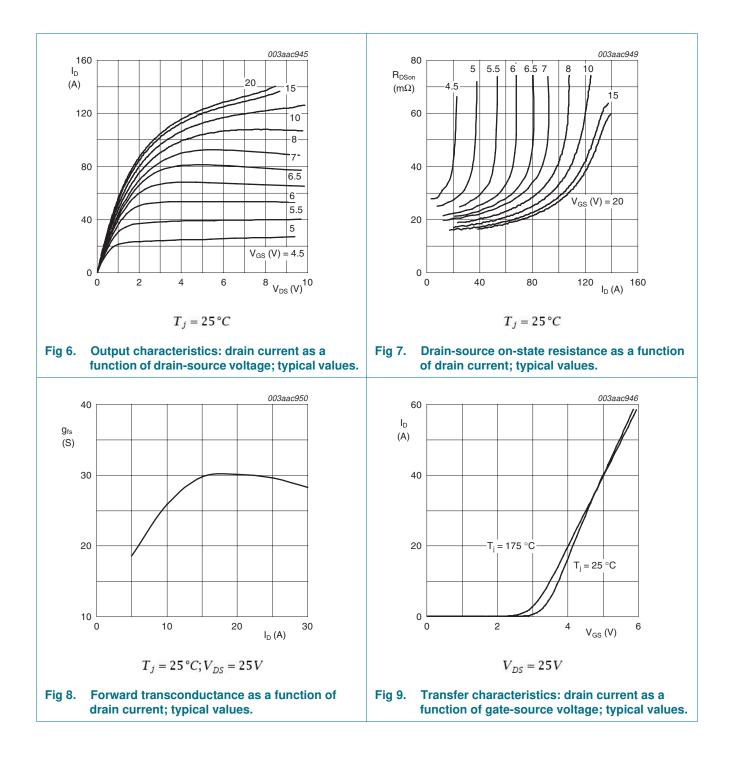


N-channel TrenchMOS standard level FET

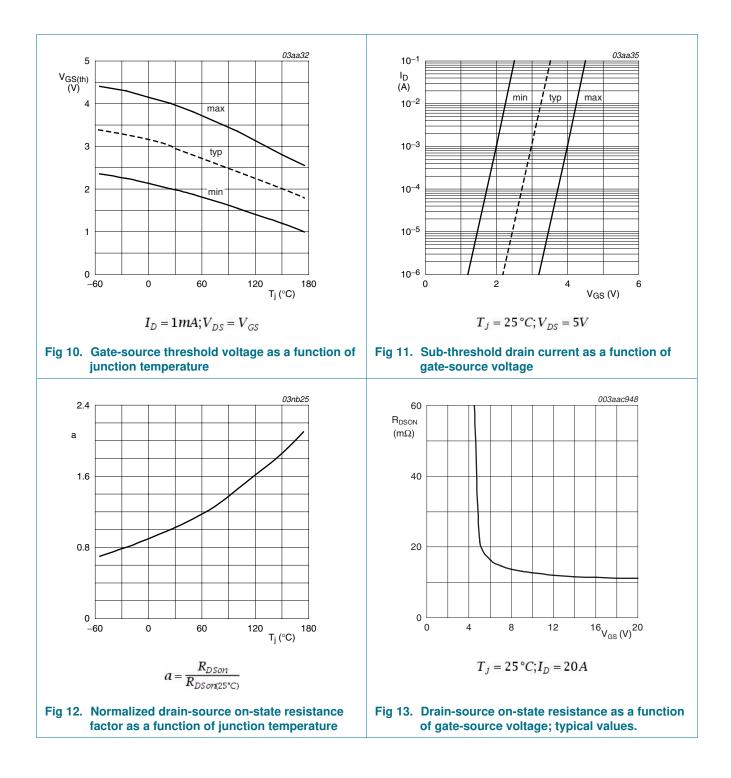
### 6. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	cteristics					
V <sub>(BR)DSS</sub> drain-source		I <sub>D</sub> = 250 μA; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C	55	-	-	V
	breakdown voltage	$I_D = 250 \ \mu A; V_{GS} = 0 \ V; T_j = -55 \ ^{\circ}C$	50	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	I <sub>D</sub> = 1 mA; V <sub>DS</sub> = V <sub>GS</sub> ; T <sub>j</sub> = 25 °C; see <u>Figure 10</u> ; see <u>Figure 11</u>	2	3	4	V
		I <sub>D</sub> = 1 mA; V <sub>DS</sub> = V <sub>GS</sub> ; T <sub>j</sub> = -55 °C; see <u>Figure 10</u>	-	-	4.4	V
		I <sub>D</sub> = 1 mA; V <sub>DS</sub> = V <sub>GS</sub> ; T <sub>j</sub> = 175 °C; see <u>Figure 10</u>	1	-	-	V
DSS	drain leakage current	$V_{DS} = 55 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	0.02	1	μA
		$V_{DS} = 55 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 175 \text{ °C}$	-	-	500	μA
IGSS	gate leakage current	$V_{DS} = 0 V; V_{GS} = 20 V; T_j = 25 \text{ °C}$	-	2	100	nA
		$V_{DS} = 0 V; V_{GS} = -20 V; T_j = 25 \text{ °C}$	-	2	100	nA
Doon	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 20 A; T <sub>j</sub> = 175 °C; see <u>Figure 12</u>	-	-	37.8	mΩ
		$V_{GS}$ = 10 V; $I_D$ = 20 A; $T_j$ = 25 °C; see <u>Figure 12</u> ; see <u>Figure 13</u>	-	12.7	18	mΩ
Dynamic ch	aracteristics					
Q <sub>G(tot)</sub>	total gate charge	$I_D = 20 \text{ A}; V_{DS} = 44 \text{ V}; V_{GS} = 10 \text{ V};$	-	21.9	-	nC
Q <sub>GS</sub>	gate-source charge	see Figure 14	-	4.64	-	nC
Q <sub>GD</sub>	gate-drain charge		-	8.1	-	nC
C <sub>iss</sub>	input capacitance	$V_{GS} = 0 V; V_{DS} = 25 V; f = 1 MHz;$	-	947	1263	pF
C <sub>oss</sub>	output capacitance	$T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure } 15}{15}$	-	223	268	pF
C <sub>rss</sub>	reverse transfer capacitance		-	105	144	pF
d(on)	turn-on delay time	$V_{DS} = 30 \text{ V}; \text{ R}_{L} = 1.5 \Omega; \text{ V}_{GS} = 10 \text{ V};$	-	13	-	ns
tr	rise time	$R_{G(ext)} = 10 \ \Omega$	-	20	-	ns
t <sub>d(off)</sub>	turn-off delay time		-	34	-	ns
t <sub>f</sub>	fall time		-	16	-	ns
Source-drai	n diode					
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = 20 A; V <sub>GS</sub> = 25 V; T <sub>j</sub> = 25 °C; see <u>Figure 16</u>	-	0.85	1.2	V
rr	reverse recovery time	$I_S = 20 \text{ A}; dI_S/dt = -100 \text{ A}/\mu\text{s}; V_{GS} = 0 \text{ V};$	-	36	-	ns
Q <sub>r</sub>	recovered charge	$V_{DS} = 30 V$	-	55	-	nC

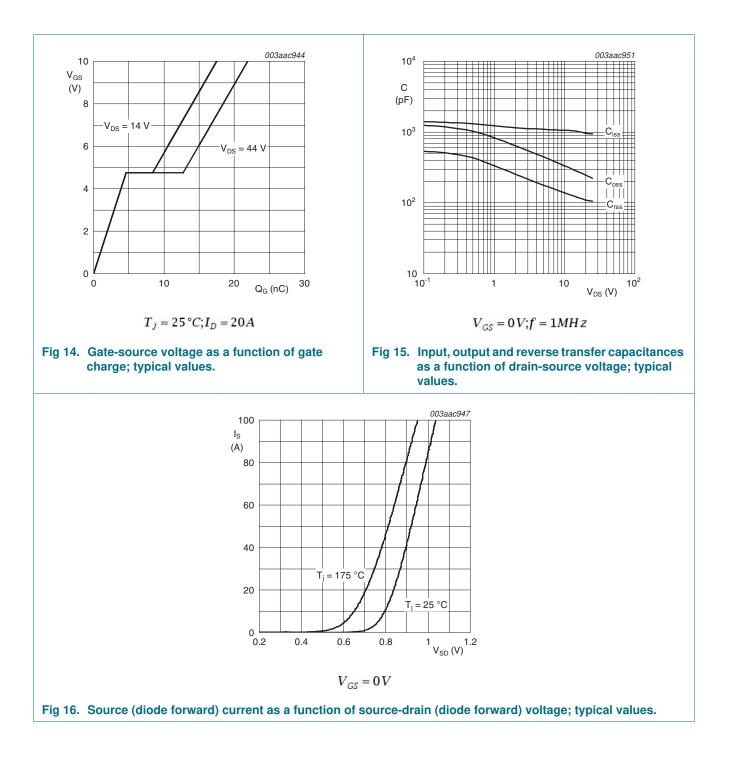
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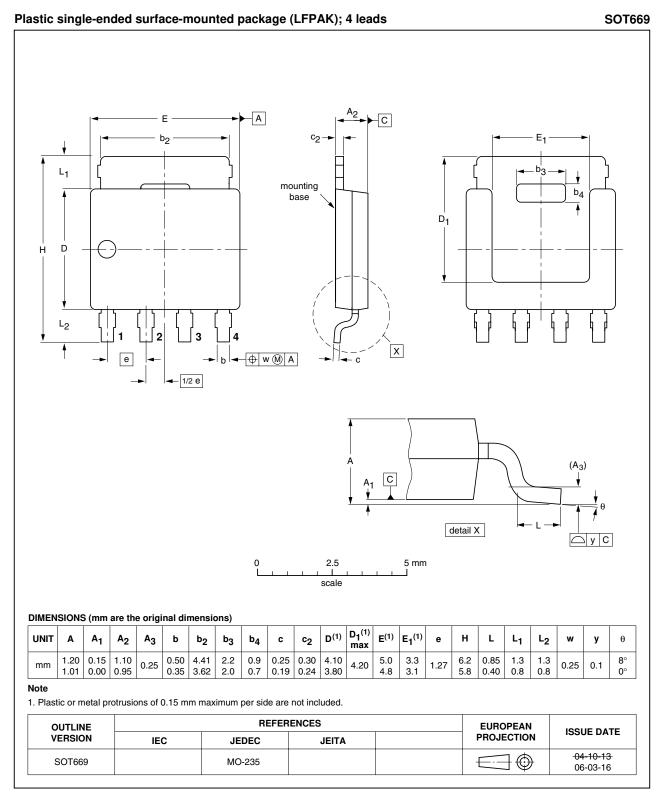


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N-channel TrenchMOS standard level FET

### 7. Package outline



#### Fig 17. Package outline SOT669 (LFPAK)

BUK7Y18-55B Product data sheet

N-channel TrenchMOS standard level FET

### 8. Revision history

Table 7.Revision his	story			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BUK7Y18-55B_4	20100407	Product data sheet	-	BUK7Y18-55B_3
Modifications:	<ul> <li>Status char</li> </ul>	nged from objective to proc	luct.	
BUK7Y18-55B_3	20100218	Objective data sheet	-	BUK7Y18-55B_2

#### N-channel TrenchMOS standard level FET

### 9. Legal information

#### 9.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <u>http://www.nexperia.com</u>.

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N-channel TrenchMOS standard level FET

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#### N-channel TrenchMOS standard level FET

### 11. Contents

1	Product profile1
1.1	General description1
1.2	Features and benefits1
1.3	Applications1
1.4	Quick reference data1
2	Pinning information2
3	Ordering information2
4	Limiting values
5	Thermal characteristics5
6	Characteristics6
7	Package outline10
8	Revision history11
9	Legal information12
9.1	Data sheet status12
9.2	Definitions12
9.3	Disclaimers
9.4	Trademarks
10	Contact information13